#### **Unapproved Minutes**

# IEEE P802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force Plenary Meeting

Webex Meeting March 16, 2021 Prepared by Mabud Choudhury

Group Name: IEEE P802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force

Date/Location: Thursday, March 16, 2021. Webex meeting.

Chair: Robert Lingle, Jr (OFS)

Editors: Ramana Murty (Broadcom), Earl Parsons (CommScope)

**Recording Secretary:** Mabud Choudhury (OFS)

Meeting Participants: Attendance is listed in Appendix A (63 attendees – based on official IMAT

attendance)

#### Call to order:

IEEE P802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force (TF) Interim WebEx meeting was convened at 10:02 AM Eastern Daylight Time (EDT/ UTC -4), Tuesday, March 16, 2021 by Robert Lingle, Jr., P802.3db TF Chair.

### **Webex Meeting Procedures:**

He instructed attendees to either add their affiliations to their names in the Webex participants list, or else list their name with affiliation in the chat window – a meeting requirement. [These two instructions were repeated multiple times throughout the meeting via Chat].

#### **Chair's Presentation:**

**Title:** "Agenda and General Information" **Presenter:** Robert Lingle, Jr. (OFS) agenda 3db 01 031621.pdf

Mr. Lingle then proceeded with reviewing the **Agenda**, Slide 3 of <u>agenda 3db 01 031621.pdf</u> and asked if there were any modifications, additions or deletions? There were none.

#### .3db Motion #1:

Move to approve the Agenda for Interim TF Teleconference, Slide 3 of agenda 3db 01 031621.pdf

- M: Mark Kimber
- S: Tom Palkert
- (Procedural > 50%)
- Motion approved by unanimous consent

#### Agenda approved at 10:05 AM

### **Approved Agenda:**

- Welcome
- Approve Agenda
- Attendance
- Goals for this meeting

- Reflector and Web
- Ground Rules
- IEEE
  - Structure, Bylaws and Rules
  - Call for Patents. IEEE Patent Policy reminder: http://www.ieee802.org/3/patent.html
  - IEEE Copyright reminder: <a href="https://standards.ieee.org/ipr/index.html">https://standards.ieee.org/ipr/index.html</a>
  - IEEE Participant reminder: http://www.ieee802.org/devdocs.shtml
  - IEEE Standards Process
- PAR & Objectives
- Chair's discussion of resolving TBDs in D0.1
- D0.1 Editors' Report
- Straw Polls & Motions
- Liaisons
- Future Meetings

**Attendance:** Chair asked attendees to use <a href="http://imat.ieee.org/">http://imat.ieee.org/</a> to record attendance (no Session Code for Plenary) and reviewed the IMAT steps to log attendance for this TF meeting. Attendance record based on IMAT only. The request to record attendance via IMAT was repeated multiple times via Chat.

**Task Force Decorum:** Chair asked for attendees to stay on mute when not speaking. Chair asked if anyone from the **Press** was present – no one indicated that they were from the Press.

#### Mr. Lingle provided Goal for the meeting:

- Review D0.1 Editors' Report and review D0.1
- Discuss TBDs in D0.1. Encourage contributions to resolve TBDs
- Consider liaison and sharing of draft with INCITS T11.2

**Reflector and Web:** Chair showed the links to the IEEE 802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force page, and the email reflector.

**TF Private Area:** Chair provided Username and Password for TF private area. All draft standards will be in private area.

Chair reviewed:

**Ground Rules:** slide 11 of <u>agenda 3db 01 031621.pdf</u> **IEEE Structure:** slide 12 of <u>agenda 3db 01 031621.pdf</u>

Important Bylaws and Rules: slide 13 of agenda 3db 01 031621.pdf

Secretary had shared the IEEE SA Patent, Copyright and Participation Policies prior to the meeting and had asked participants to be familiar these policies. Mr. Lingle asked if any participants had questions, and that there were no questions.

**IEEE SA Patent Policy:** Mr. Lingle provided overview of slides 14-18 of <u>agenda 3db 01 031621.pdf</u>. Chair made "**Call for Potentially Essential Patents**" at 10:14 AM. No response from TF participants.

**IEEE SA Copyright Policy:** Mr. Lingle showed slides 19-21 of <u>agenda 3db 01 031621.pdf</u> entitled "IEEE SA Copyright Policy" overview

**IEEE SA Participation Policy:** Mr. Lingle showed the participation policy overview slides 22-24 of agenda 3db 01 031621.pdf.

Mr. Lingle then reviewed the Overview of IEEE 802.3 Standards Process – completed Study Group Phase, and now in Task Force Comment Phase (slide 26 of agenda 3db 01 031621.pdf).

Chair showed links for Approved Project Documents: PAR, CSD and Objectives slide 30 of <a href="mailto:agenda\_3db\_01\_031621.pdf">agenda\_3db\_01\_031621.pdf</a>). Mr. Lingle then showed the TF Objectives and Timeline, indicating that TF is 1 to 2 months behind timeline.

Chair then reviewed TBDs in D0.1. He indicated that there are 6 key TBDs to be resolved: For Transmit Characteristics

- Center wavelength for 50m PMD
- TDECQ for 50m PMD
- Overshoot/undershoot for 50m & 100m PMDs

For Receive Characteristics

Stressed Receiver sensitivity

For Test Methodology

Number of taps for 50m PMD

Additionally, there is a need for proposals for the MDI.

#### **Editors' Report:**

**Title:** "Updated Baseline for 100 Gb/s per Lane Optical PMDs Supporting 50 and 100m OM4 MMF" **Presenters:** Editors Ramana Murty (affiliated with Broadcom Inc.) and Earl Parsons (affiliated with CommScope)

murty 3db 01a 031621.pdf

Version 01a update: correct typo, Slide 15, third and fourth bullet: Table 167-14 (was incorrectly 167-4).

- Editorial team responsibility:
  - o Earl Parsons: Sections 167.1 –167.6, 167.9 –167.11
  - o Ramana Murty: Sections 167.7 –167.8
- Status:
  - Draft 0.1 posted March 15, 2021.
  - Open for comments March 16, 2021. Please send comments by marking up D0.1 or sending e-mail to editors.
  - Please send comments by March 26, 2021, 12:00 midnight AOE.
  - Plan to post comments against D0.1 prior to and resolve comments at the April 1, 2021 meeting.
- Editors reviewed Clause 167 (new clause number assigned to P802.3) additions for D0.1
- Technical discussion followed. Topics included: fiber chromatic dispersion, fiber cabled attenuation, TECQ, number of taps for 50 m vs. 100 m as it relates to TECQ, future contribution on wavelength.

#### Liaison:

TF reviewed and updated – to more completely reflect status of D0.1 – liaison letter from 802.3 WG to INCITS T11.2 making P802.3db TF D0.1 draft available to T11.2: IEEE 802d3 to T11-2 0321 draft2.pdf

#### .3db Motion #2:

- Move that the IEEE P802.3db Task Force approve <u>IEEE 802d3 to T11-2 0321 draft2.pdf</u> with editorial license granted to the Chair (or his appointed agent) as liaison communication from the IEEE 802.3 Working Group to INCITS T11.2
- M: John D'Ambrosia
- S: Piers Dawe
- Y: N: A:
- Technical (>/=75% of 802.3 voters)
- Motion is approved by unanimous consent.

**Late contribution:** the request to make contribution for <u>latchman\_3db\_01\_031621.pdf</u> was past Chair's announced deadline for contribution requests. The contribution was also submitted past the submission deadline. Chair asked if anyone in TF objected to allowing this contribution to be presented, time permitting? No one responded with an objection.

#### Contribution #1:

Title: " Addressing TDECQ VRx"

Presenter: Ryan Latchman (affiliated with MACOM)

latchman 3db 01 031621.pdf

- Presentation provides:
  - Support for lower cost Transmit & Receive specifications: TDECQ for VRx specifications
    - TDECQ / SECQ & Impact of BT filter
    - Review of Measured Results
  - Addresses TBDs in Table 167-7 Transmit characteristics, of D0.1
- Technical discussion followed on number of taps, 50 m vs. 100 m specifications, approaches for lower cost 50 m specifications that are still interoperable with 100 m specifications.
- Presenter welcomed feedback from the group and answered clarifying questions. He indicated that he would provide follow-up contribution based on comments from TF.

#### **Future meetings:**

- See: <a href="http://ieee802.org/3/calendar.html">http://ieee802.org/3/interims/index.html</a>
- P802.3db TF Ad Hoc Teleconferences are currently scheduled:
- Biweekly on Thursdays at 12 Noon to 2 pm Eastern US (EDT/UTC -4): <a href="http://www.ieee802.org/3/db/public/adhoc/index.html">http://www.ieee802.org/3/db/public/adhoc/index.html</a>
- Next TF Ad Hoc meeting:

#### Thursday, April 1, 2021, 10am to 12 Noon Eastern US (EDT/UTC -4)

Ad Hoc meetings will be converted to TF interims when TF business requires

On TF interim teleconferences, only 802.3 voters may vote on TF motions

#### .3db Motion #3:

Move to Adjourn TF Telephonic Interim Meeting

- M: Ali Ghiasi
- S: James Young
- (Procedural > 50%)
- Motion passes by unanimous consent

The Task Force Interim meeting was adjourned at 11:57 AM EDT/ UTC -4, Tuesday, March 16, 20

## **Next Meeting:**

Scheduled P802.3db TF Interim Webex meeting for Thursday, April 1, 2021 at 12:00 Noon – 2:00 PM EDT/UTC -4.

Appendix A: Attendance List IEEE P802.3db Task Force WebEx Plenary Meeting 63 individuals attended on Tuesday, 16 March 2021, 10:02 AM – 11:57 AM EDT/UTC -4

	Employer	Affiliation
1 Abbott, John	Corning Incorporated	Corning Incorporated
2 Aekins, Rob	Legrand	Legrand
3 Bhatt, Vipul	II-VI Incorporated	Finisar Corporation
4 Bruckman, Leon	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
5 Calvin, John	Keysight Technologies	Keysight Technologies
6 Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.
7 Choudhury, Mabud	OFS	OFS
8 Chuang, Keng Hua	Hewlett Packard Enterprise	Hewlett Packard Enterprise
9 D'Ambrosia, John	Futurewei Technologies	Futurewei Technologies
10 Dawe, Piers J G	NVIDIA	Nvidia
11 DeSanti, Claudio	Dell	Dell
12 Didde, Stephen	Keysight Technologies	Keysight Technologies
13 Estes, David	Spirent Communications	Spirent Communications
14 FAn, DAWEI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
15 Ferretti, Vincent	Corning Incorporated	Corning Incorporated
16 Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Inphi
17 He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
	Broadcom Inc.	Broadcom Inc.
18 Healey, Adam 19 Heck, Howard		Intel Corporation
· ·	Intel Corporation	Credo Semiconductor
20 Hidaka, Yasuo	Credo Semiconductor	
21 Kamino, John	OFS Uiseas Floatria (USA) Inc.	OFS History Floatica (HSA) Inc.
22 Kim, Kihong/Joshua	Hirose Electric (USA), Inc.	Hirose Electric (USA), Inc.
23 Kim, Yongbum	Tenstorrent	Tenstorrent
24 Kimber, Eric	Semtech Ltd	Semtech Ltd
25 Klempa, Michael	University of New Hampshire InterOperability Laboratory (UNH-IOL)	Amphenol Corporation
26 Kota, Kishore	Inphi Corporation	Inphi Corporation
27 Latchman, Ryan	MACOM	MACOM
28 Lewis, David	Lumentum Inc.	Lumentum Inc.
29 Li, Mike-Peng	Intel Corporation	Intel Corporation
30 Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
31 Lin, Youxi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
32 Lingle, Robert	OFS	OFS
33 Liu, Karen	Lightwave Logic	Lightwave Logic
34 Lusted, Kent	Intel Corporation	Intel Corporation
35 Maguire, Valerie	The Siemon Company	The Siemon Company
36 Malicoat, David	Malicoat Networking Solutions	Malicoat Networking Solutions; SENKO Advanced Components
37 Maniloff, Eric	Ciena Corporation	Ciena Corporation
38 Marques, Flavio	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC
39 Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
40 mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
41 Milicevic, Mario	MaxLinear	MaxLinear
42 Murty, Ramana	Broadcom Inc.	Broadcom Corporation
43 Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
44 Palkert, Thomas	Macom, Samtec	Samtec-Macom
45 Parsons, Earl	CommScope, Inc.	CommScope, Inc.
46 Piehler, David	Dell Technologies	Dell
47 Quan, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
	Keysight Technologies	Keysight Technologies
48 Rabinovich, Rick		
49 Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated  North Fact System Associates
50 Sayre, Edward	Samtec, Inc.	North East System Associates
51 She, Qingya	Fujitsu Network Communications	Fujitsu Network Communications
52 Shubochkin, Roman	OFS	OFS
53 Son, Yung Sung	Optomind Inc	Optomind Inc
54 Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDIRES
55 Sun, Junqing	Credo Semiconductor	Credo Semiconductor
56 Sun, Yi	OFS	OFS
57 Swanson, Steven	Corning Incorporated	Corning Incorporated
58 Tang, Yi	Cisco Systems, Inc.	Cisco Systems, Inc.
59 Ulrichs, Ed	Intel	Intel
60 Vanderlaan, Paul	UL LLC	UL LLC
61 Withey, James	Fluke Corporation	Fluke Corporation
62 Zhiwei, Yang	ZTE Corporation	ZTE Corporation
63 Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd